

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP40T15G uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

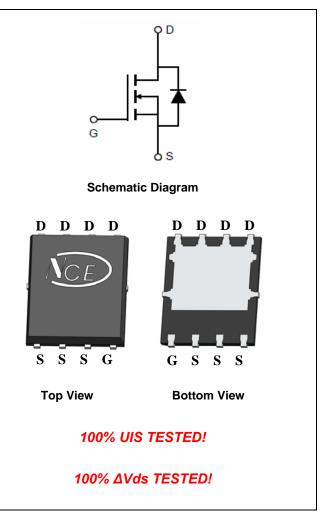
General Features

V_{DS} =40V,I_D =150A
R_{DS(ON)}=1.6mΩ (typical) @ V_{GS}=10V
R_{DS(ON)}=1.9mΩ (typical) @ V_{GS}=4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T15G	NCEP40T15G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	VDS	40	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous (Silicon Limited)	Ι _D	150	А	
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	106	А	
Pulsed Drain Current (Package Limited)	I _{DM}	600	А	
Maximum Power Dissipation	PD	135	W	
Derating factor		1.08	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	720	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C	



Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	0.93	°C/W	
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Electrical Characteristics (Tc=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	····		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			L.			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.2	1.5	2.2	V
		V _{GS} =10V, I _D =75A	-	1.6	1.8	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =75A	-	1.9	2.3	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =75A		80	-	S
Dynamic Characteristics (Note4)			L.			
Input Capacitance	C _{lss}	V _{DS} =20V,V _{GS} =0V,	-	6000	7150	PF
Output Capacitance	C _{oss}		-	1450	1700	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	100	145	PF
Switching Characteristics (Note 4)			L.			
Turn-on Delay Time	t _{d(on)}		-	12.5	-	nS
Turn-on Rise Time	tr	V _{DD} =20V,I _D =75A V _{GS} =10V,R _G =1.6Ω	-	7.0	-	nS
Turn-Off Delay Time	t _{d(off)}		-	50	-	nS
Turn-Off Fall Time	t _f		-	8.5	-	nS
Total Gate Charge	Qg		-	95	115	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=20V, I_{D}=75A,$	-	15		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	11		nC
Drain-Source Diode Characteristics				ıI		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =75A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	150	А
Reverse Recovery Time	t _{rr}	T_J = 25°C, I_F = I_S	-		31	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-		110	nC

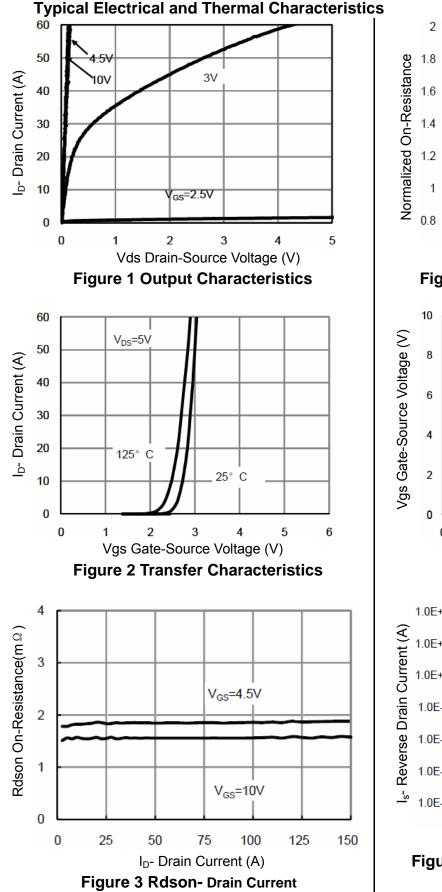
Notes:

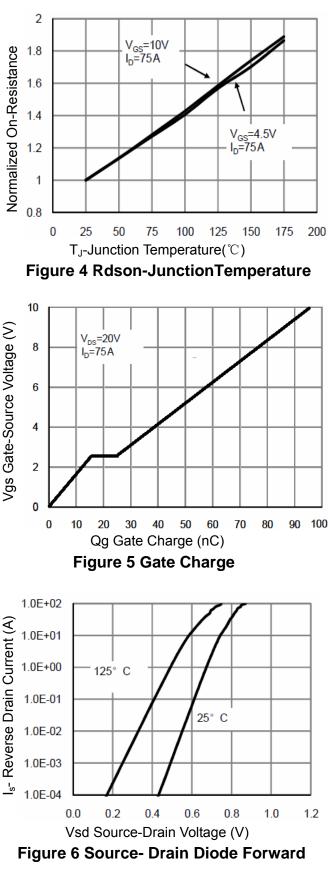
1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ C$,V_{DD}=20V,V_G=10V,L=0.5mH,Rg=25 Ω









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NCEP40T15G

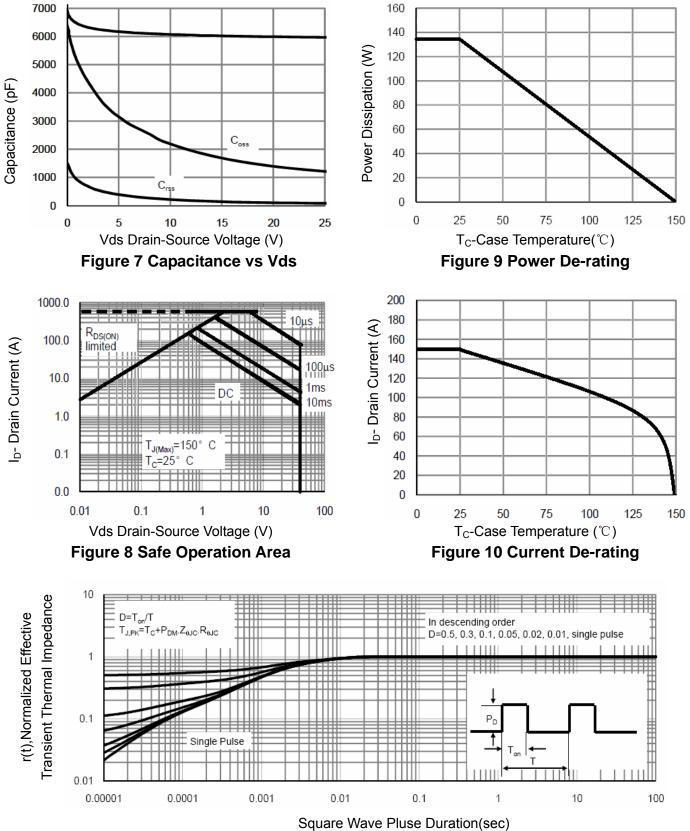
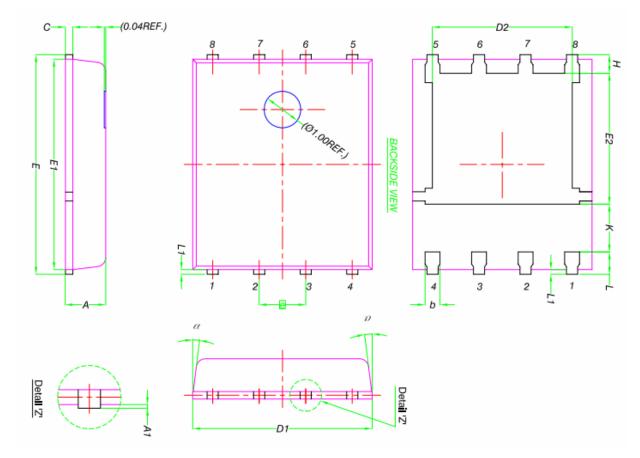


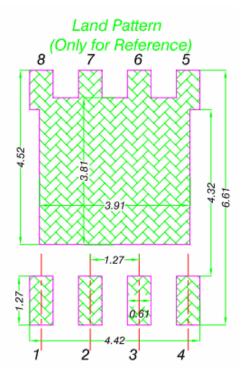
Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
А	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
E	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
К	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	0°	-	12°	





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